ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoo nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level p	arts, the	declaration	n encor		lower lev	el materia	als for	which th	item is an assembly e manufacturer has eclaration.
1752-2 1.1	ırd	Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa										
Supplier Information															
Company Name * Company Unio				Unique ID Au	Response Date *				Response Document ID						
SEMTECH CORPORATION	00-847-9941		DUNS	2023-08-04											
Contact Name *		Title - Contact		Phone - Con	Email - Contact *				D 1			A 41			
Karen Pimental		QA Customer/Docun	nent Contro	805-498-211	kpimental@semtech.com			m	Dupli	cate Co	ontact ->	Autno	rizea Re	presentative	
Authorized Representative		Title - Representative	е	Phone - Rep	Email - Representative *			*	Supplier Comments or URL for Additional Information						
Karen Pimental		QA Customer/Docur	nent Contr	805-498-211	kpimental@semtech.com			m							
Requester Item Number		Mfr Item Number		Mfr Item Name)	Effectiv	e Date	Version Manufa		cturing Site	ring Site Weight *		UO	М	Unit Type
		uClamp1301ZV.F		μClamp® 1-L	P			China		0.3	50632	mg		Each	
Alternate Recommend	lation				Alternate It			Item Co	n Comments						
Manufacturing Proce	ss In	formation													
Terminal Plating / Grid Array Material			Terminal Base Alloy		J-STD-020 MSL Ra	ting Peak Proc		ess Body Temperat		ture Max Time at Peak Tem		ak Tempe	erature Number of Reflor		of Reflow Cycles
Nickel/Gold (Ni/Au)			Not Appl	icable	1			260 C		30 se		30 seco	econds 3		
Comments uClamp1301ZV.F is REA	ACH-	compliant product,	per EU Re	gulation EC1	907/2006 to inclu	de the	most red	ent addi	tions t	o the SVH	C candid	ate list o	of subs	stances.	Ck KP

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type *** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a ?RoHS restricted substance?) in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier?s liability and the Company?s remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted **RoHS Declaration *** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature**

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of			Level	Substance Category	S		Substance	CAS	Exempt	Weight	Unit of	Tolerance		PPM	
	Name		Material	Weight	Measure				oubstance outegory			Cubstance	<u> </u>	Lxcilipt	Weight	Measure	-	+		
+1 -1	Die	+M -M	Silicon chip	0.237112	mg	+C	-C	Supplier	Silicon (Si)	+S	-S	Silicon	7440-21-3		0.237112	mg			676,24	
+1 -1	Epoxy Encapsulation	+M -M	Ероху	0.048932	mg	+C	-C	Supplier	CEL-C-7732-4	+S	-s	epoxy resin (1)	Proprietary		0.002446	mg			6,977.6	
		_								+S	Ş	epoxy resin (2)	Proprietary		0.000489	mg			1,395.5	
										+S	-S	Harddener	Proprietary		0.000978	mg			2,791.0	
										+S	-S	Carbon black	1333-86-4		0.000097	mg			279.10	
										+S	-S	Additive(1)	Proprietary		0.000489	mg			1,395.5	
										+S	-S	Additive(2)	Proprietary		0.000489	mg			1,395.5	
										+S	-S	Solvent	Proprietary		0.002446	mg			6,977.6	
										+S	-S	Amorphous silica	60676-86-0		0.041494	lmg			118,34	
		+M -M	PI	0.002773	mg	+C	-C	Supplier	HD4100	+S	-s	N-Methyl-2-pyrrolidone	872-50-4		0.000000	mg			1.6608	
										+S	-S	3,6,9-Trioxaundecameth	109-17-1		0.001109	mg			3,163.4	
										+S	-S	Hydroxyethyl methacry	868-77-9		0.000276	mg			789.19	
										+S	-S	Polyamic Acid Ester	Proprietary		0.001109	mg			3,163.4	
										+S	-S	Aromatic oxime	Proprietary		0.000277	mg			790.85	
		+M -M	Bump	0.02341	mg	+C	-C	Supplier	Ni /CZ1556 A	+S	-S	Ni	10101-97-0		0.022946	mg			65,443	
						+C	-C	Supplier	AU	+S	-S	Au	13967-50-5		0.000468	mg			1,335.5	
		+M -M	Lamination	0.0384	mg	+C	-C	Supplier	LC2844	+S	-S	silica	Proprietary		0.010176	mg			29,021	
										+S	-S	release film (polyethyle	25038-59-9		0.023424	mg			66,805	
										+S	-S	adhesive (Carbon black	1333-86-4		0.000192	mg			547.58	
										+S	-S	adhesive(Acrylic resin)	Proprietary		0.003072	mg			8,761.3	
										+S	-s	adhesive (epoxy resin)	Proprietary		0.001536	mg			4,380.6	